



SPECIFICATION

(Reference sheet)

• Supplier : Samsung electro-mechanics • Samsung P/N : CL21B473KCFNNNE

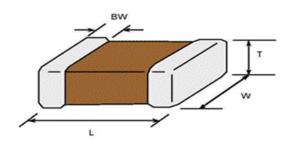
• Product : Multi-layer Ceramic Capacitor • Description : CAP, 47 nF, 100V, ±10%, X7R, 0805

A. Samsung Part Number

<u>CL</u> <u>21</u> <u>B</u> <u>473</u> <u>K</u> <u>C</u> <u>F</u> <u>N</u> <u>N</u> <u>N</u> <u>E</u> ① ② ③ ④ ⑤ ⑥ ⑦ ⑧ ⑨ ⑩ ⑪

1	Series	Samsung Multi-layer Ceramic Capacitor		
2	Size	0805 (inch code)	L: 2.00 ± 0.10 mm	W: 1.25 ± 0.10 mm
3	Dielectric	X7R	Inner electrode	Ni
4	Capacitance	47 nF	Termination	Cu
(5)	Capacitance	±10 %	Plating	Sn 100% (Pb Free)
	tolerance		Product	Normal
6	Rated Voltage	100 V	10 Special	Reserved for future use
7	Thickness	1.25 ± 0.10 mm	Packaging	Embossed Type, 7" reel

B. Structure and dimension



Compung D/N	Dimension(mm)				
Samsung P/N	L	W	Т	BW	
CL21B473KCFNNNE	2.00±0.10	1.25±0.10	1.25±0.10	0.50+0.2/-0.3	

C. Samsung Reliablility Test and Judgement condition

	Performance	Test condition		
Capacitance	Within specified tolerance	1kl±10% 1.0±0.2Vrms *A capacitor prior to measuring the capacitance is heat treated at 150 ℃+0/-10 ℃ for 1hour and maintained in		
Tan δ (DF) 0.025 max.		ambient air for 24±2 hours.		
Insulation 10,000Mohm or 500Mohm⋅ <i>µ</i> F		Rated Voltage 60~120 sec.		
Resistance Whichever is smaller				
Appearance No abnormal exterior appearance		Microscope (×10)		
Withstanding No dielectric breakdown or		200% of the rated voltage		
Voltage	mechanical breakdown			
Temperature	X7R			
Characterisitcs	(From -55℃ to 125℃, Capacitance cha	nge should be within ±15%)		
Adhesive Strength	No peeling shall be occur on the	500g·F, for 10±1 sec.		
of Termination	terminal electrode			
Bending Strength	Capacitance change: within ±12.5%	Bending to the limit (1mm)		
		with 1.0mm/sec.		
Solderability	More than 75% of terminal surface	SnAg3.0Cu0.5 solder		
	is to be soldered newly	245±5℃, 3±0.3sec.		
		(preheating : 80~120 ℃ for 10~30sec.)		
Resistance to	Capacitance change : within ±7.5%	Solder pot : 270±5℃, 10±1sec.		
Soldering heat	Tan δ, IR : initial spec.			
Vibration Test	Capacitance change : within ±5%	Amplitude : 1.5mm		
	Tan δ, IR : initial spec.	From 10Hz to 55Hz (return : 1min.)		
		2hours × 3 direction (x, y, z)		
Moisture	Capacitance change: within ±12.5%	With rated voltage		
Resistance	Tan δ : 0.05 max	40±2℃, 90~95%RH, 500+12/-0hrs		
	IR: 500Mohm or 25Mohm · μF			
	Whichever is smaller			
High Temperature	Capacitance change: within ±12.5%	With 200% of the rated voltage		
Resistance	Tan δ : 0.05 max	Max. operating temperature		
	IR: 1000Mohm or 50Mohm $\cdot \mu$ F			
Whichever is smaller		1000+48/-0hrs		
Temperature	Capacitance change : within ±7.5%	1 cycle condition		
Cycling	Tan δ, IR : initial spec.	Min. operating temperatur → 25 °C		
		$ ightarrow$ Max. operating temperature $ ightarrow$ 25 $^{\circ}\!$		
		5 cycle test		
		5 cycle test		

X The reliability test condition can be replaced by the corresponding accelerated test condition.

D. Recommended Soldering method:

Reflow (Reflow Peak Temperature: 260+0/-5°C, 10sec. Max)



Product specifications included in the specifications are effective as of March 1, 2013.

Please be advised that they are standard product specifications for reference only.

We may change, modify or discontinue the product specifications without notice at any time.

So, you need to approve the product specifications before placing an order.

Should you have any question regarding the product specifications,

please contact our sales personnel or application engineers.